

# SI2321DS-T1-GE3-VB Datasheet

# P-Channel 20-V (D-S) MOSFET

MOSFET PRODUCT SUMMARY					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
	0.060 at V <sub>GS</sub> = - 10 V	- 4.0			
- 20	0.065 at V <sub>GS</sub> = - 4.5 V	- 3.5	10 nC		
	0.080 at V <sub>GS</sub> = - 2.5 V	- 2.0			

G 1

S 2

**TO-236** (SOT-23)

3 D

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
   Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switch
- PA Switch
- DC/DC Converters

	$A = 25 \ ^{\circ}C$ , unless oth		· · · .		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 20	v		
Gate-Source Voltage	V <sub>GS</sub>	± 12	v		
	T <sub>C</sub> = 25 °C		- 4 <sup>e</sup>		
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	I <sub>D</sub>	-3.2		
	T <sub>A</sub> = 25 °C	טי	- 3 .5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 2 .5 <sup>b, c</sup>	A	
Pulsed Drain Current	I <sub>DM</sub>	- 10			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 2.1		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	- 1.0 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		2.5		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.6	w	
	T <sub>A</sub> = 25 °C	U I	1.25 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		0.8 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	≤5 s	R <sub>thJA</sub>	75	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	50	0/11		

Notes:

- a. Based on T<sub>C</sub> = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 °C/W.
- e. Package limited.

MOSFET SPECIFICATIONS Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Symbol	Test Conditions	IVIII.	тур.	IVIAX.	Unit	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>DS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 20	T		V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			- 13.4		-	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.9		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 0.5		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 V, V_{GS} = -4.5 V$	- 10			А	
	D(on)	$V_{GS} = -10 \text{ V}, I_D = -3 \text{ A}$		0.060			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -2.5 \text{ A}$		0.065		Ω	
	20(01)	$V_{GS} = -2.5 \text{ V}, I_D = -2 \text{ A}$		0.080			
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = -5 V, I_D = -3 A$		15		S	
Dynamic <sup>b</sup>	010						
Input Capacitance	C <sub>iss</sub>			835			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		180		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			155			
		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.1 A		10		nC	
Total Gate Charge	Qg			6.4			
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 3.1 A		1.7			
Gate-Drain Charge	Q <sub>gd</sub>			3.4		-	
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.9	4.4	8.8	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			22	33		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.4 $\Omega$		20	30	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{D} = -3.1$ A, $V_{GEN} = -4.5$ V, $R_{g} = 1$ $\Omega$		28	42		
Fall Time	t <sub>f</sub>			9	18		
Drain-Source Body Diode Characteristi	cs					1	
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.1	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 1 0		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3.1 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			23	35	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			12	20	nC	
Reverse Recovery Fall Time	ta	I <sub>F</sub> = - 3.1 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		15			
Reverse Recovery Rise Time	t <sub>b</sub>			8		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

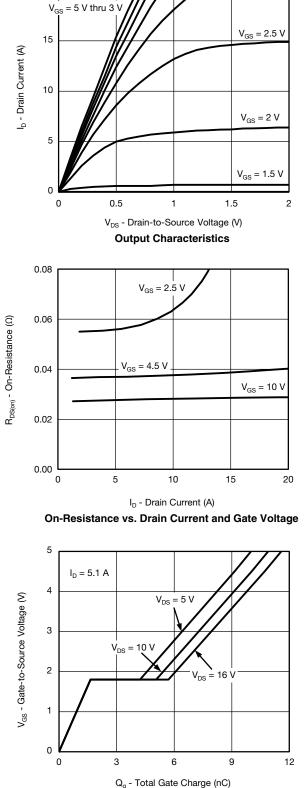
b. Guaranteed by design, not subject to production testing.

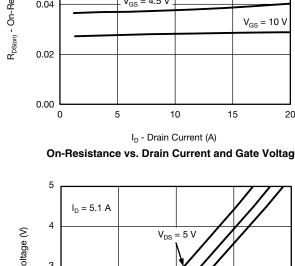
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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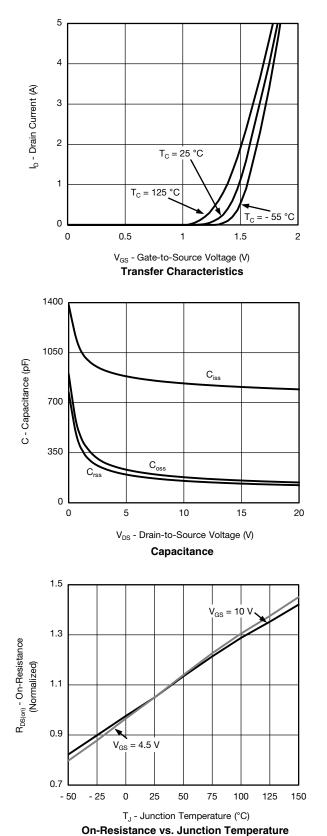


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

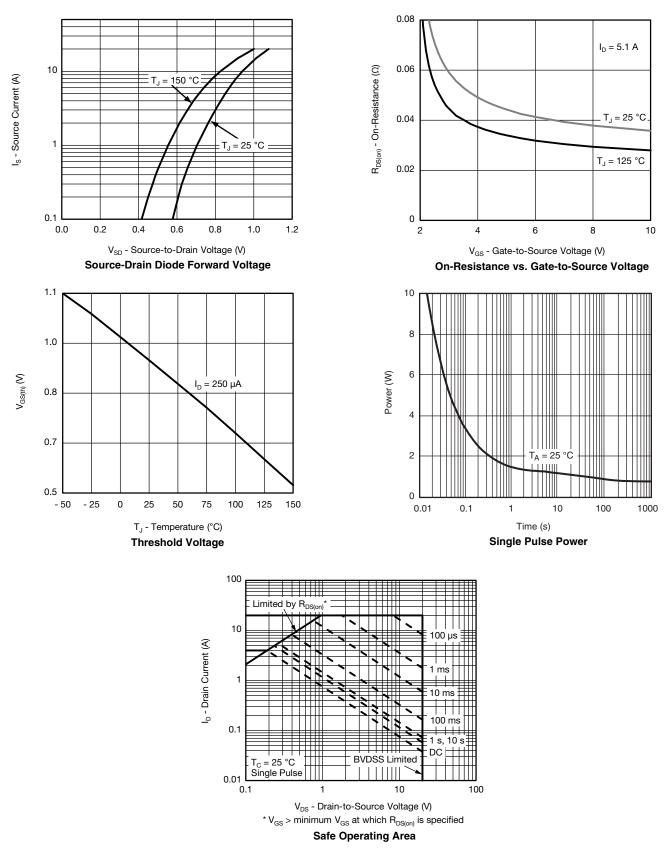




Gate Charge



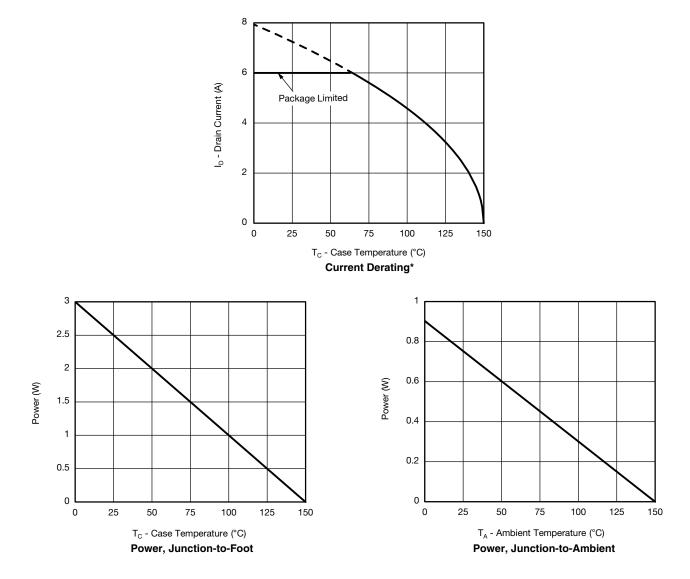




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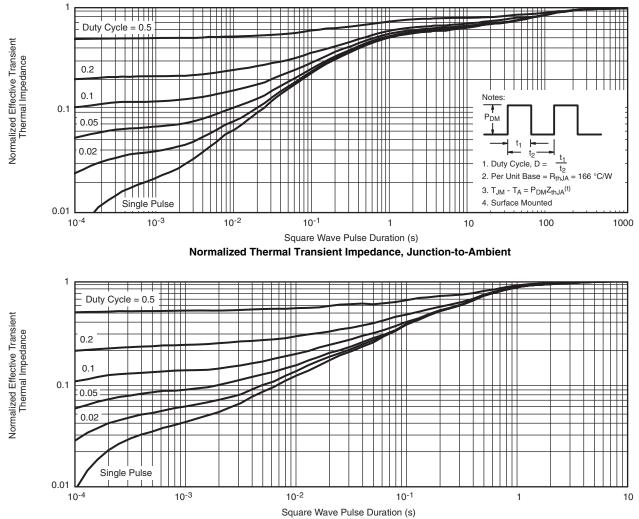
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



# SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025	5 Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09-J DWG: 5479	ul-01	•			

# SI2321DS-T1-GE3-VB



## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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